LVDS Dual 2x2 Crosspoint/Repeater Switch

Features

- Dual 2x2 Crosspoint/Repeater Switch
- Meets or Exceeds the Requirements of ANSI TIA/ EIA-644-1995
- Designed for Signaling Rates up to 650 Mbit/s (325 MHz)
- Operates from a 3.3V Supply: –40°C to 85°C
- Low Voltage Differential Signaling with Output Voltages of ±350mV into:
  – 100Ω load (PI90LV024)
  – 50Ω load Bus LVDS Signaling (PI90LVB024)
- Accepts ±350mV differential inputs
- Wide common mode input range: 0.2V to 2.7V
- Output drivers are high impedance when disabled or when $V_{CC} \leq 1.5V$
- Inputs are open, short, and terminated fail safe
- Propagation Delay Time: 3.5ns
- ESD protection is 10kV on bus pins
- Bus Pins are High Impedance when disabled or with V_{CC} less than 1.5V
- TTL Inputs are 5V Tolerant
- Power Dissipation at 400Mbit/s of 250mW
- Packaging (Pb-free & Green Available):
  – 28-pin QSOP (Q)
  – 28-pin TSSOP (L)

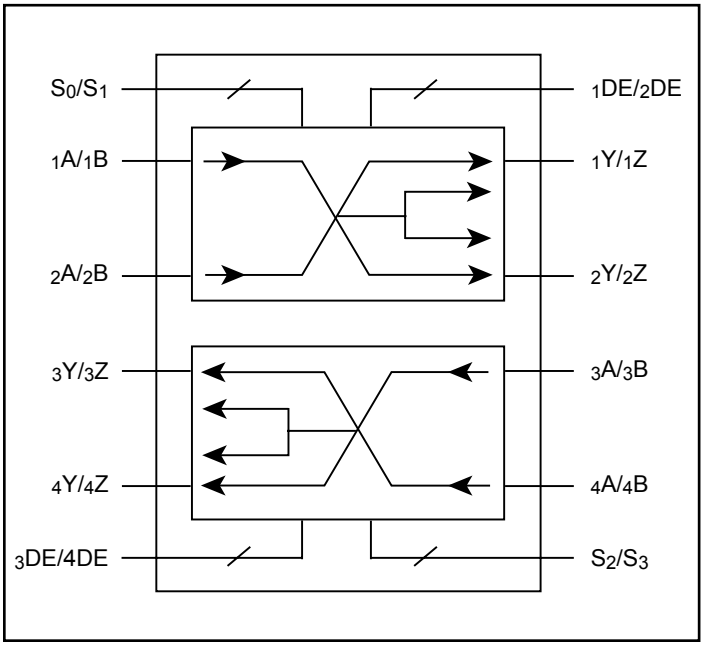
Description

The PI90LV024 and PI90LVB024 are monolithic dual 2x2 asynchronous crosspoint/repeater switches. The crosspoint function is based on a multiplexer tree architecture. Each 2x2 switch can be considered as a pair of 2:1 multiplexers that share the same inputs. The signal path through each switch is fully differential with minimal propagation delay. The signal path is unregistered, so no clock is required for the data inputs. The signal line drivers and receivers use Low Voltage Differential Signaling (LVDS) to achieve signaling rates as high as 650 Mbps.

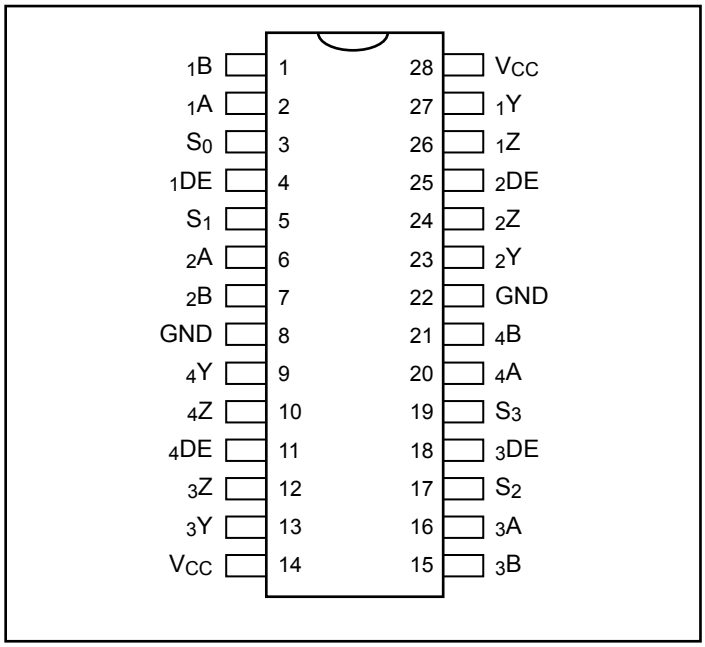
The LVDS standard provides a minimum differential output voltage magnitude of 247mV into a 100Ω load and receipt of 100mV signals with up to 1V of ground potential difference between a transmitter and receiver. The PI90LVB024 doubles the output drive current to achieve Bus LVDS signaling levels with a 50Ω load.

The intended application of these devices is for loop-through and redundant channel switching for both point-to-point base-band (PI90LV024) and multipoint (PI90LVB024) data transmissions over controlled impedance media. The package pin assignments enables easy routing for applications requiring signal feedback.

Block Diagram



Pin Configuration



MUX Truth Table

Input		Output		Function
S_3, S_1	S_2, S_0	${}_1Y/{}_1Z$ - ${}_3Y/{}_3Z$	${}_2Y/{}_2Z$ - ${}_4Y/{}_4Z$	
0	0	${}_1A/{}_1B$ - ${}_3A/{}_3B$	${}_1A/{}_1B$ - ${}_3A/{}_3B$	Splitter
0	1	${}_2A/{}_2B$ - ${}_4A/{}_4B$	${}_2A/{}_2B$ - ${}_4A/{}_4B$	Splitter
1	0	${}_1A/{}_1B$ - ${}_3A/{}_3B$	${}_2A/{}_2B$ - ${}_4A/{}_4B$	Router
1	1	${}_2A/{}_2B$ - ${}_4A/{}_4B$	${}_1A/{}_1B$ - ${}_3A/{}_3B$	Router

Note:
1. Setting *n*DE to 0 will set Ouput *n*Y/*n*Z to High Impedance.

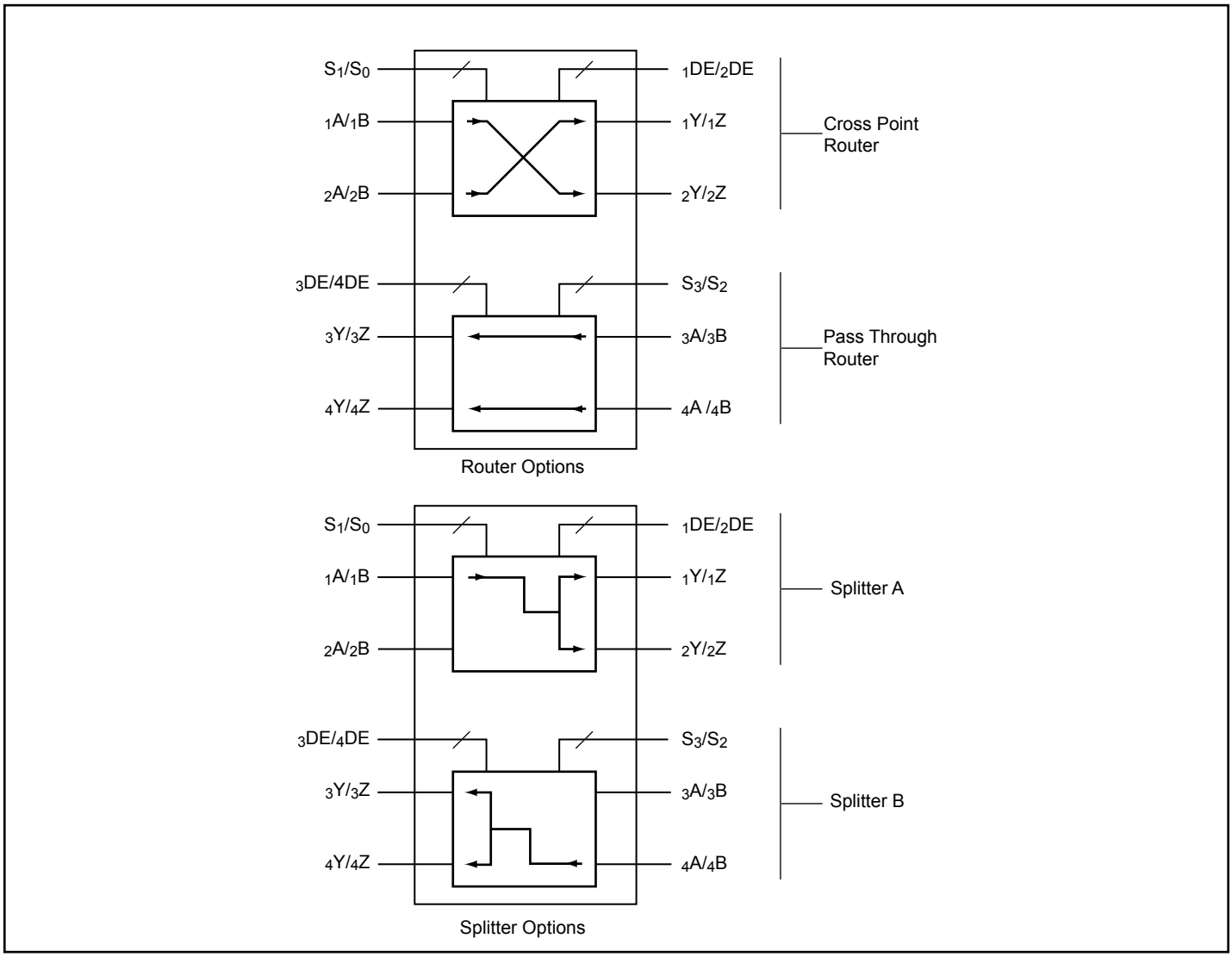


Figure 1. Possible Signal Routing

Absolute Maximum Ratings Over Operating Free-Air Temperature(1)

Supply Voltage Range, V_{CC}(2)	–0.5V to 4V
Voltage Range (DE, S_0, S_1)	–0.5 to 6V
Input Voltage Range,	V_I (A or B)–0.5V to V_{CC} + 0.5V
Electrostatic Discharge: A, B, Y, Z, and GND(3)	Class 3, A: 16kV, B:600V
All Pins	Class 3, A: 7kV, B:500V
Storage Temperature Range	–65°C to 150°C
Lead Temperature 1, 6 mm (1/16 inch) from case for 10 seconds	260°C

Notes:

1. Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "Recommended Operating Conditions" is not implied. Exposure to Absolute-Maximum-Rated conditions for extended periods may affect device reliability.
2. All voltage values, except differential I/O bus voltages, are with respect to ground terminal.
3. Tested in accordance with MIL-STD-883C Method 3015.7

Recommended Operating Conditions

Parameter	Desctiption		Min.	Typ.	Max.	Units
V_{CC}	Supply Voltage		3.0	3.3	3.6	V
V_{IH}	High-Level Input Voltage	S_0 - S_3, $_1D_E$ - $_4D_E$	2			
V_{IL}	Low-Level Input Voltage				0.8	
$\lvert V_{ID} \rvert$	Magnitude of Differential Input		0.1		0.6	
V_{IC}	Common-Mode Input Voltage (see fig 2)		$\frac{\lvert V_{ID} \rvert}{2}$		$2.4 - \frac{\lvert V_{ID} \rvert}{2}$	
					V_{CC} -0.8	
T_A	Operating Free-air temperature		-40		85	°C

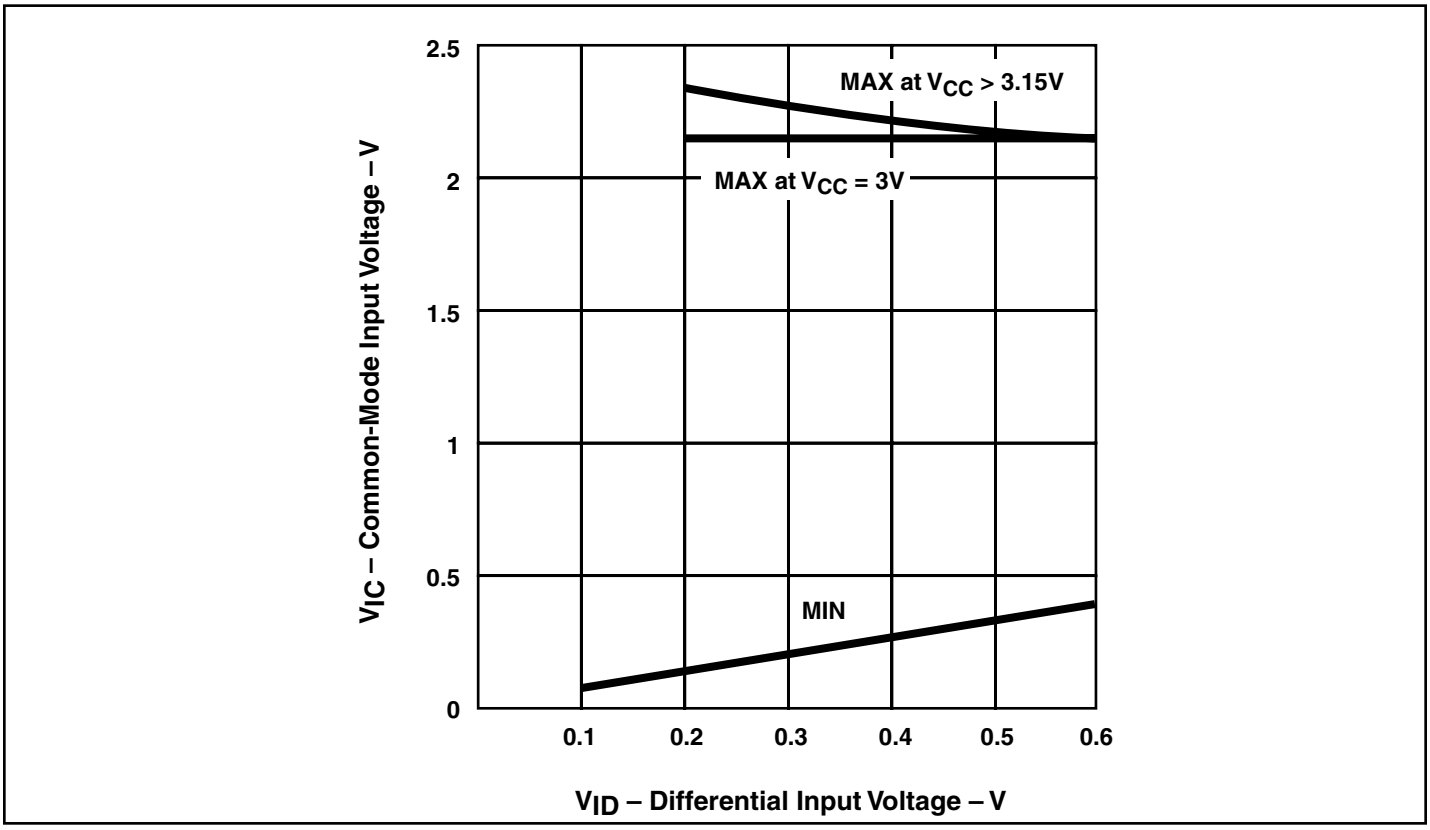


Figure 2. Common-Mode Input Voltage vs. Differential Voltage

Receiver Electrical Characteristics Over Recommended Operating Conditions (unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max	Units
V_{ITH+}	Postive-going differential input voltage threshold	V_{CM} = 1.2V			100	mV
V_{ITH-}	Negative-going differential input voltage threshold		-100			
I_I	Input Current (A or B inputs)	V_I = 0V	-2		-20	µA
		V_I = 2.4V	-1.2			
$I_{I(OFF)}$	Power-off Input current (A or B inputs)	V_{CC} = 0V			20	

Receiver / Driver Electrical Characteristics Over Recommended Operating Conditions

(unless otherwise noted)

Symbol	Parameter		Test Conditions		Min.	Typ.	Max	Units
V_{OD}	Differential Output Voltage Magnitude		R_L = 100Ω (LV024)	See Fig. 3	247	440	590	mV
ΔV_{OD}	Change in Differential Output Voltage Magnitude between Logic States				-50		50	
$V_{OC(SS)}$	Steady-State Common-Mode Output Voltage		R_L = 100Ω (LVB024)	See Fig. 4	1.062		1.375	V
$\Delta V_{OC(SS)}$	Change in Steady-State Common-Mode Output Voltage between Logic States				-50	3	50	mV
$V_{OC(PP)}$	Peak-to-peak common-mode output voltage						150	
I_{CC}	Supply Current		No Load			16	24	mA
			R_L = 100Ω (LV024)			26	40	
			R_L = 50Ω (LVB024)			42	54	
			Both Channels Disabled			6	12	
I_H	High-Level Input Current	DE	V_{IH} = 5V				40	nA
		S_1, S_2, S_3, S_4					-3	µA
I_L	Low-Level Input Current	DE	V_{IL} = 0.8V				-20	nA
		S_1, S_2, S_3, S_4					10	µA
I_{OS}	Short Circuit Output Current		V_{OY} or V_{OZ} = 0V				-10	mA
			V_{OD} = 0V				-10	
I_{OZ}	High-Impedance Output Current		V_{OD} = 600mV			1.5	±25	nA
			V_O - 0V or V_{CC}			1.5	±25	
$I_{O(OFF)}$	Power-Off Output Current		V_{CC} - 0V, V_O = 3.6V			1.5	±40	
C_{IN}	Input Capacitance					3		pF
			S_0 - S_3, $_1D_E$ - $_4D_E$			8		

Note:

1. All typical values are at 25°C and with a 3.3V supply

Differential Receiver to Driver Switching Characteristics Over Recommended Operating Conditions

(unless otherwise noted)

Symbol	Parameter		Test Conditions	Min.	Typ.	Max.	Units
t_{PLH}	Differential propagation delay, low-to-high		C_L = 10pF (see fig. 5)		4.0	6.0	ns
t_{PHL}	Differential propagation delay, high-to-low				4.0	6.0	
$t_{sk(p)}$	Pulse skew ($\lvert t_{PHL} - t_{PLH} \rvert$)				0.5	-	
t_r	Transistion, low-to-high	LV024			1.0	1.5	
		LVB024			0.8	1.3	
t_f	Transition, high-to-low	LV024			1.0	1.5	
		LVB024			0.8	1.3	
t_{PHZ}	Propagation delay time, high-level to high impedance output		See fig. 6		4.0	10	
t_{PLZ}	Propagation delat time, low-level to high impedance output				4.3	10	
t_{PZH}	Propagation delat time, high-level to high impedance output				3.0	10	
t_{PZL}	Propagation delat time, high-level to lowimpedance output				2.0	10	
$t_{PHL}\_R_1\_D_X$	Channel-to-channel skew, receiver to driver(2)				95		ps
$t_{PLH}\_R_1\_D_X$					95		
$t_{PHL}\_R_2\_D_X$					95		
$t_{PLH}\_R_2\_D_X$					95		

Notes:

1. All typical values are at 25°C and with a 3.3V supply
2. These parametric values are measured over supply voltage and temperature ranges recommended for the device

Parameter Measurement Information

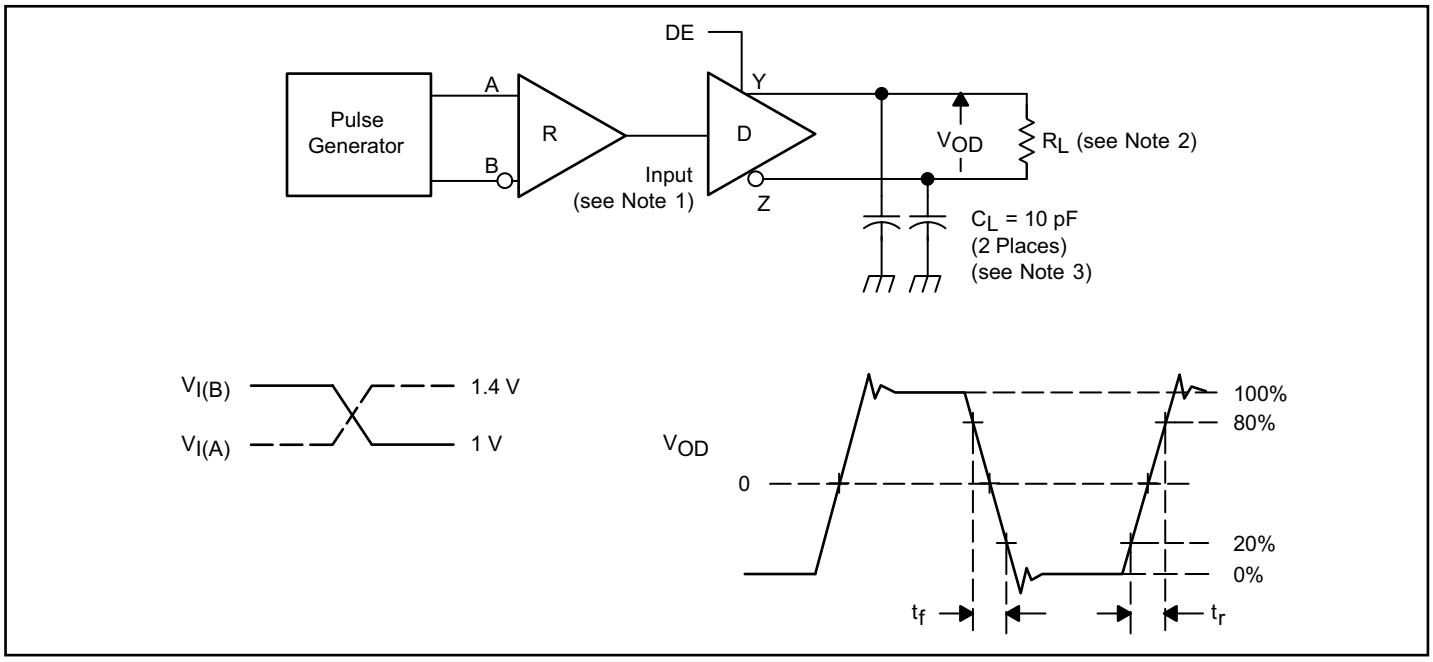


Figure 3. Test Circuit and Voltage Definitions for the Differential Output Signal

Notes:
1. All input pulses are supplied by a generator having the following characteristics: t_r or $t_f \leq$ 1ns, pulse repetition rate (PRR) - 50 Mpps, pulse width = 10 ±0.2ns.
2. R_L = 100Ω or 50Ω ±1%.
3. C_L includes instrumentation and fixture capacitance within 6mm of the D.U.T.
4. The measurement of VOC(PP) is made on test equipment with a –3dB bandwidth of at least 300 MHz.

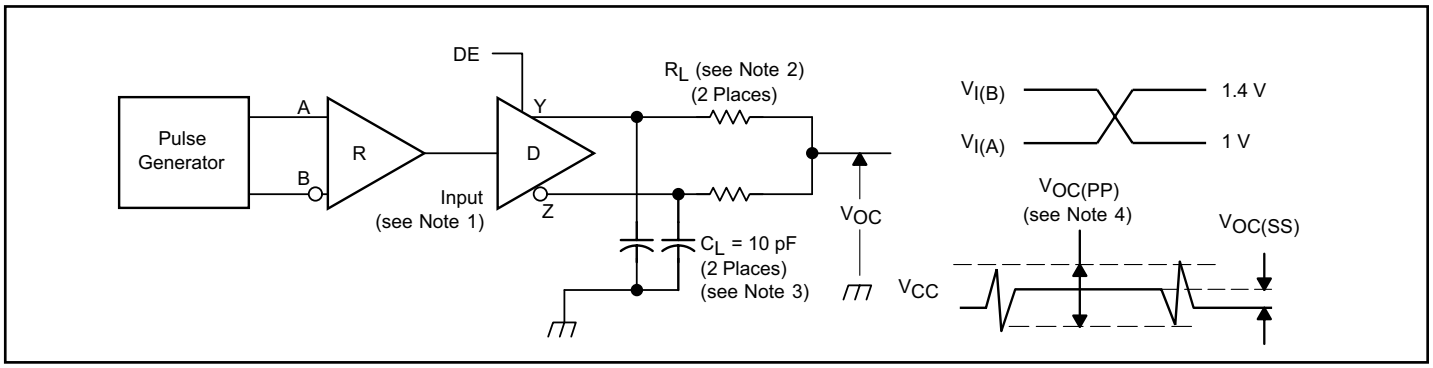


Figure 4. Test Circuit and Definitions for the Driver Common-Mode Output Voltage

Notes:
1. All input pulses are supplied by a generator having the following characteristics: t_r or $t_f \leq$ 1ns, pulse repetition rate (PRR) - 50 Mpps, pulse width = 10 ±0.2ns.
2. R_L = 100Ω or 50Ω ±1%.
3. C_L includes instrumentation and fixture capacitance within 6mm of the D.U.T.
4. The measurement of $V_{OC(PP)}$ is made on test equipment with a –3dB bandwidth of at least 300 MHz.

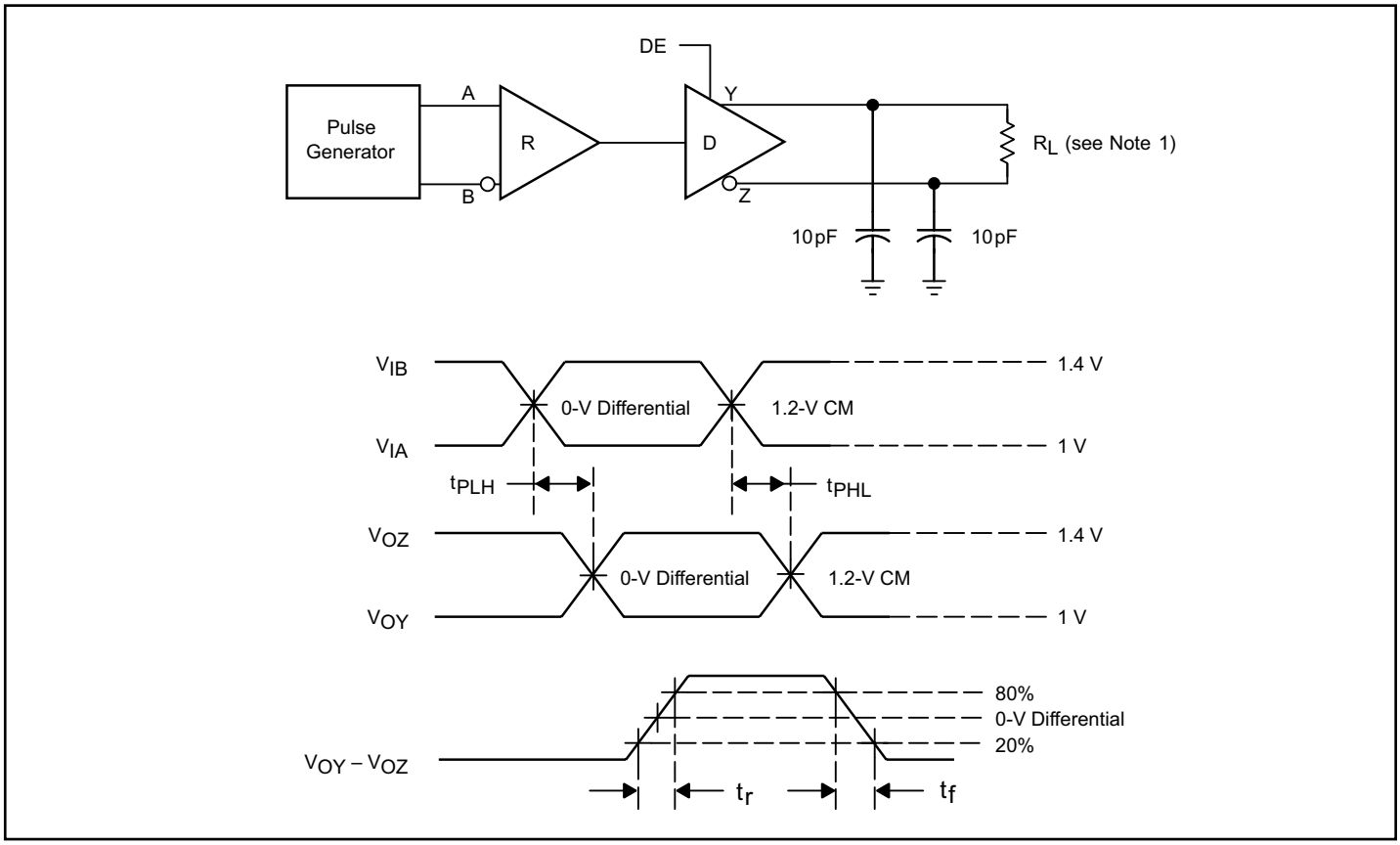


Figure 5. Differential Receiver to Driver Propagation Delay and Driver Transition Time Waveforms

Notes:
1. R_L = 100Ω or 50Ω ±1%
2. All input pulses are supplies by a generator having the following characteristics: pulse repetition rate (PPR) = 50 Mpps, pulse width = 10 ±0.2ns.

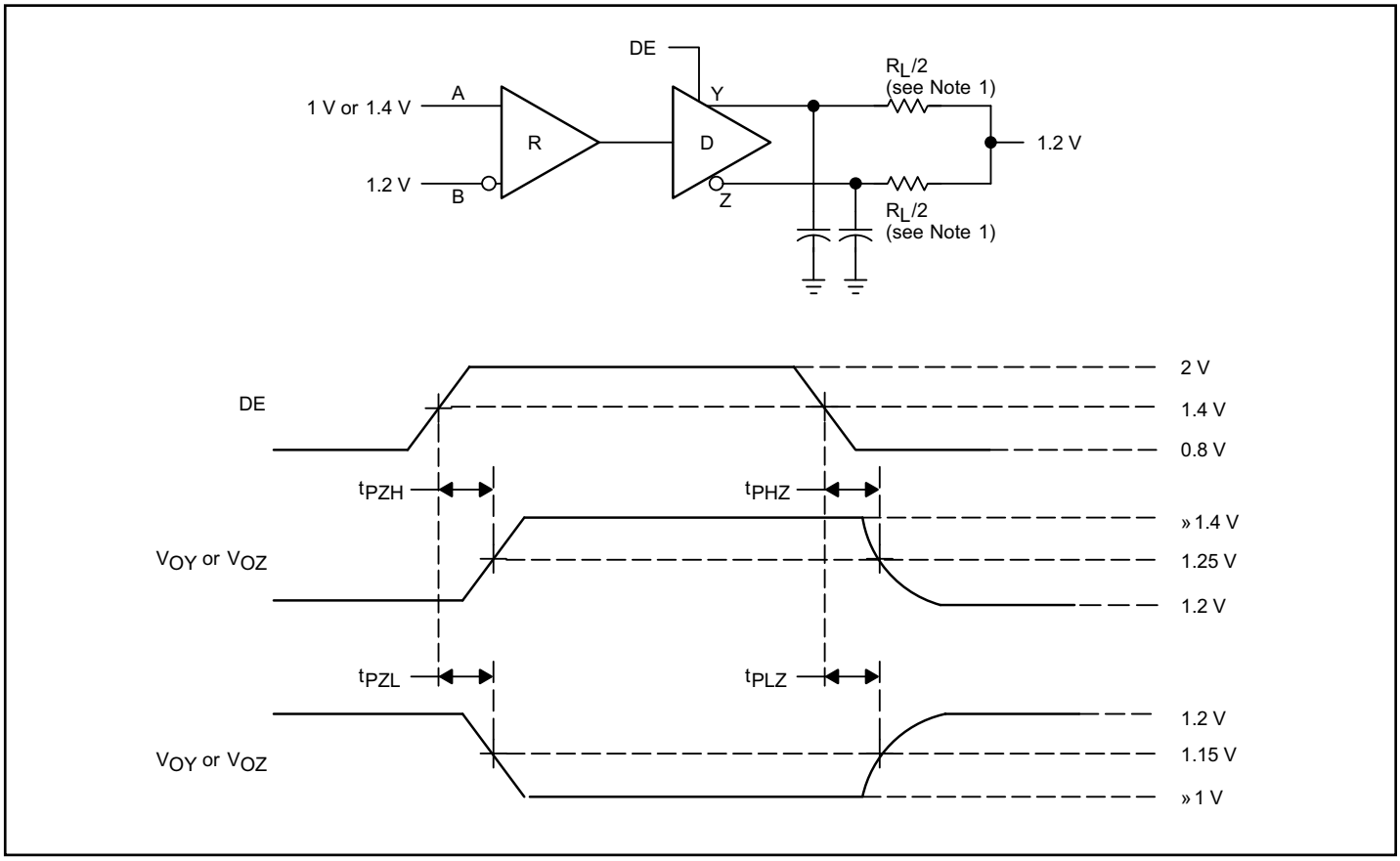


Figure 6. Enable and Disable Timing Circuit

Notes:

1. R_L = 100Ω or 50Ω ±1%
2. All input pulses are supplies by a generator having the following characteristics: pulse repetition rate (PPR) = 0.5 Mpps, pulse width = 500 ±10ns.

Typical Characteristics

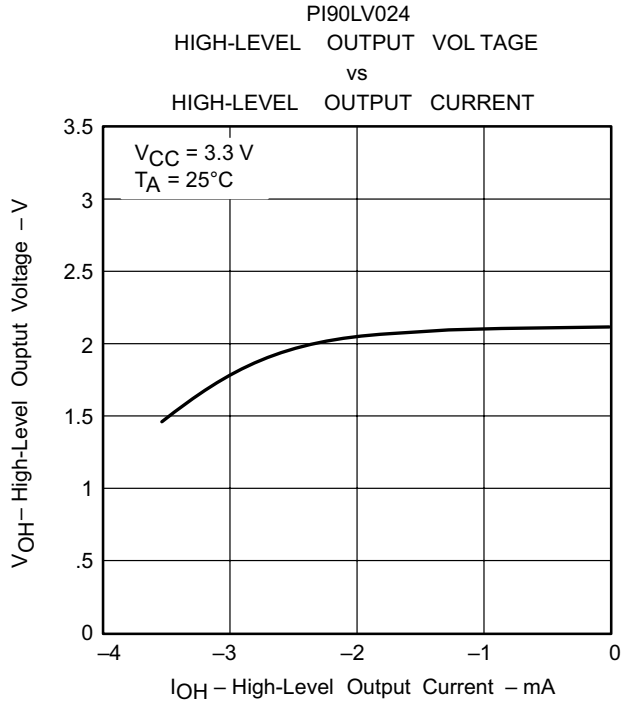


Figure 7

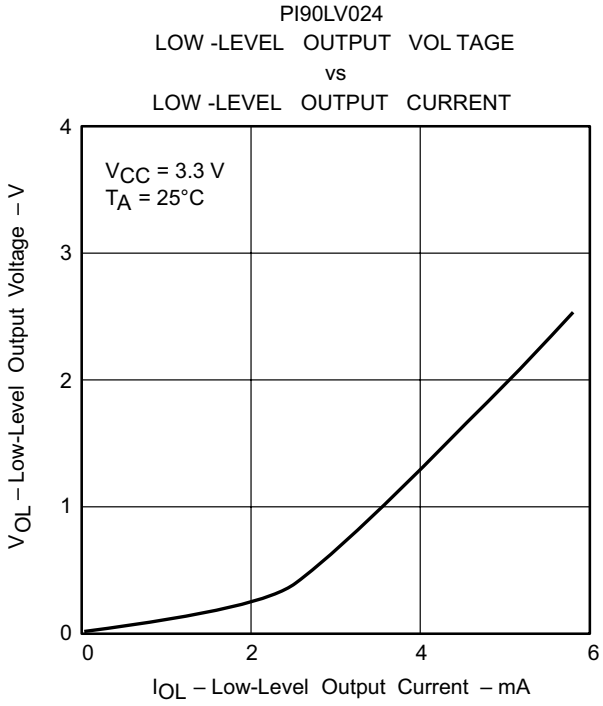


Figure 8

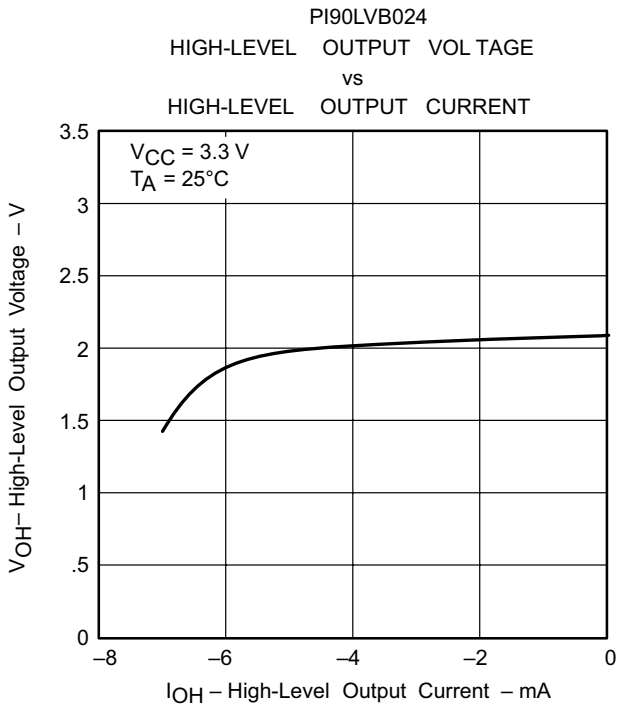


Figure 9

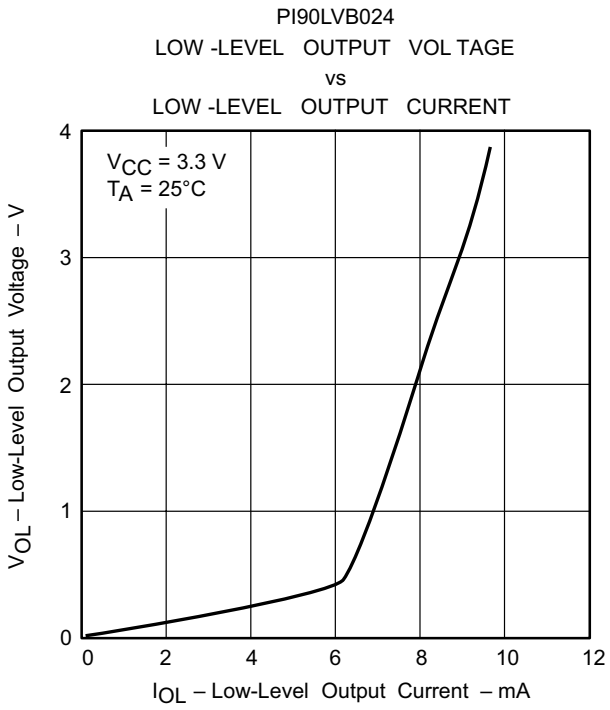
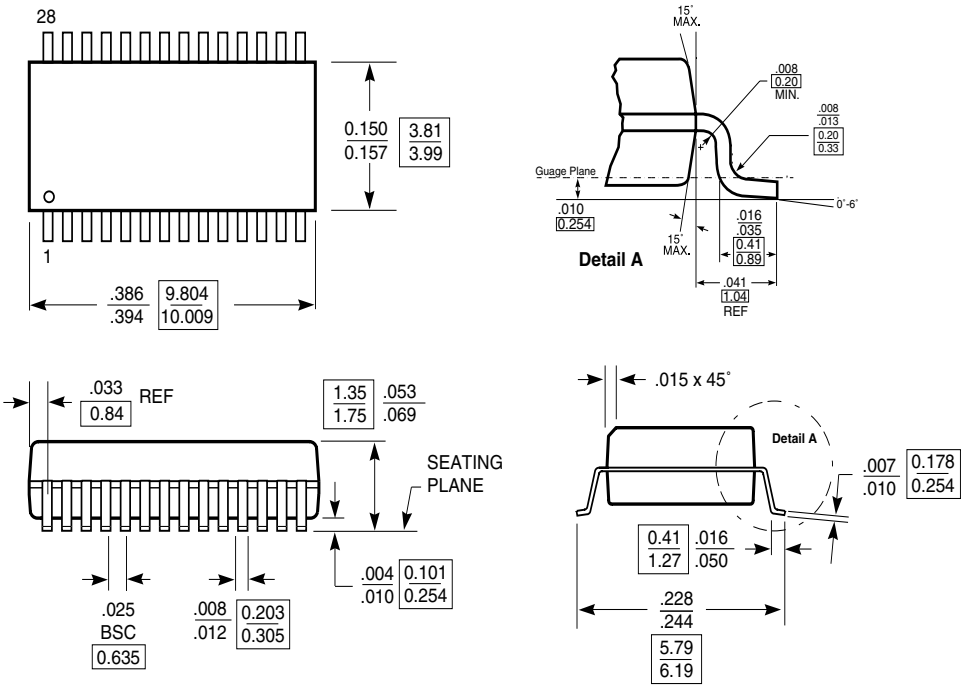
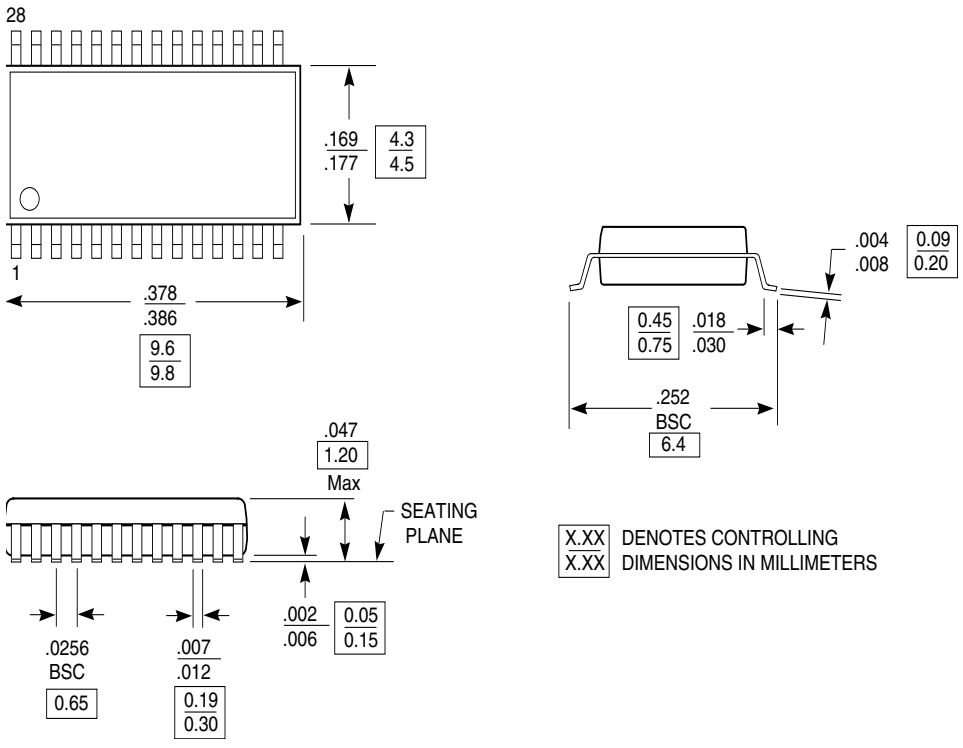


Figure 10

Packaging Mechanical: 28-Pin QSOP (Q)



Packaging Mechanical: 28-Pin TSSOP (L)



Ordering Information

Ordering Code	Package Code	Packaging Description
PI90LV024Q	Q	28-pin 150-mil SOIC
PI90LV024QE	Q	Pb-free & Green, 28-pin 150-mil SOIC
PI90LV024L	L	28-pin 170-mil TSSOP
PI90LV024LE	L	Pb-free & Green, 28-pin 170-mil TSSOP
PI90LVB024Q	Q	28-pin 150-mil SOIC
PI90LVB024QE	Q	Pb-free & Green, 28-pin 150-mil SOIC
PI90LVB024L	L	28-pin 170-mil TSSOP
PI90LVB024LE	L	Pb-free & Green, 28-pin 170-mil TSSOP

Notes:
1. Thermal Characteristics can be found on the company web site at www.pericom.com/packaging/